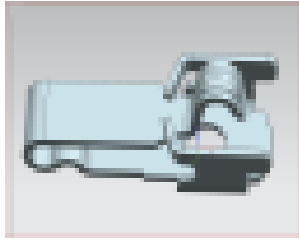


Clips summary

Pulse Part Number SW0180N



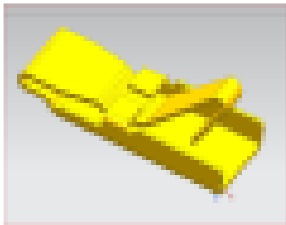
Plating

3u"MIN GOLD PLATING ON CONTACT AREA,GOLD FLASH PLATING ON SOLDER AREA,50u" MIN NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
1.0H Clips	3.55*1.5*1.4	SUS304-H T0.1mm

Pulse Part Number SW0174N



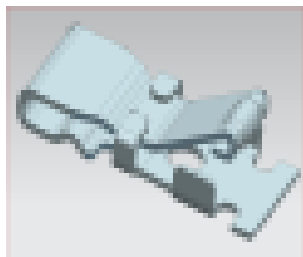
Plating

3u"MIN GOLD PLATING ON CONTACT AREA,GOLD FLASH PLATING ON SOLDER AREA,50u" MIN NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
0.4H Clips	2.5*1.0*0.8	SUS304-H T=0.05mm

Pulse Part Number SW0166N



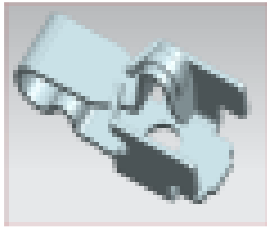
Plating

3u"MIN GOLD PLATING ON CONTACT AREA,GOLD FLASH PLATING ON SOLDER AREA,50u" MIN NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
0.5H Clips	3.35*1.5*0.9	SUS304-H T=0.08

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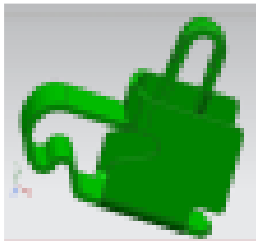


Plating

8u" Min GOLD PLATING ON CONTACT AREA,3u"
Min GOLD PLATING ON SOLDER AREA,50u" MIN
NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
1.5H Clips	3.55*1.5*1.9	C17200 T0.1mm

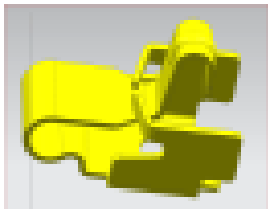


Plating

10u" Min GOLD PLATING ON CONTACT AREA,3u"
Min GOLD PLATING ON SOLDER AREA,50u" MIN
NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
2.5H Clips	3.55*1.5*3	Ycut-FX-EH T0.1mm

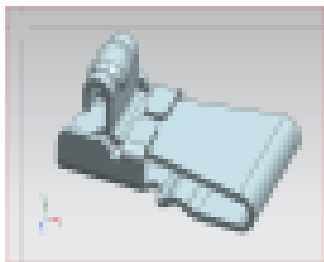


Plating

3u"MIN GOLD PLATING ON CONTACT AREA,GOLD
FLASH PLATING ON SOLDER AREA,50u" MIN
NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
2.0H Clips	3.55*1.5*2.5	SUS304-H T0.1mm

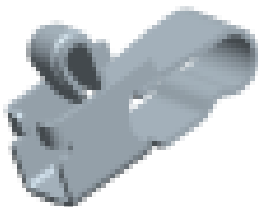


Plating

3u" MIN GOLD PLATING ON CONTACT AREA, GOLD FLASH PLATING ON SOLDER AREA, 50u" MIN NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
0.9H Clips	2.8*1.54*1.1	SUS304-H T0.1mm

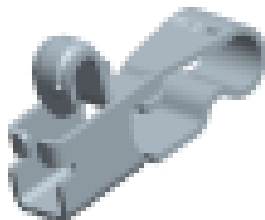


Plating

10u" Min GOLD PLATING ON CONTACT AREA, 3u" Min GOLD PLATING ON SOLDER AREA, 50u" MIN NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
1.4-1.7H Clips	3.4*1.2*2.1	C17460-H T0.1mm



Plating

10u" Min GOLD PLATING ON CONTACT AREA, 3u" Min GOLD PLATING ON SOLDER AREA, 50u" MIN NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
1.1-1.4H Clips	3.4*1.1*1.8	C17460-H T0.1mm

Pulse Part Number SW0178N



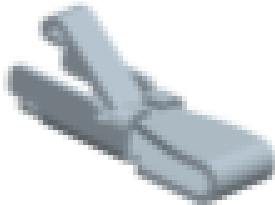
Plating

10u" Min GOLD PLATING ON CONTACT AREA,3u"
Min GOLD PLATING ON SOLDER AREA,50u" MIN
NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
1.1-1.4H Clips	3.4*1.1*1.8	YCUT-FX-EH

Pulse Part Number SW0177N



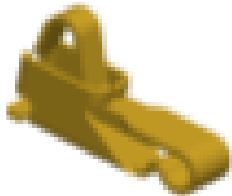
Plating

10u" Min GOLD PLATING ON CONTACT AREA,3u"
Min GOLD PLATING ON SOLDER AREA,50u" MIN
NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
0.65-0.8H Clips	2.8*1.0*1.1	C5210-EH

Pulse Part Number SW0176N



Plating

10u" Min GOLD PLATING ON CONTACT AREA,3u"
Min GOLD PLATING ON SOLDER AREA,50u" MIN
NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
1.1-1.5H Clips	3.42*0.9*1.8	C5210-EH

Pulse Part Number SW0171N



Plating

8u" Min GOLD PLATING ON CONTACT AREA,3u"
Min GOLD PLATING ON SOLDER AREA,50u" MIN
NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
3.2H Clips	4.9*2*4.2	C5210-1/2H

Pulse Part Number SW0170N



Plating

3u"MIN GOLD PLATING ON CONTACT AREA,GOLD
FLASH PLATING ON SOLDER AREA,50u" MIN
NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
0.25H Clips	3.66*1.5*0.7	SUS304-H T0.08mm

Pulse Part Number SW0168N



Plating

3u"MIN GOLD PLATING ON CONTACT AREA,GOLD
FLASH PLATING ON SOLDER AREA,50u" MIN
NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
0.86H Clips	3.33*1.5*1.36	stainless steel

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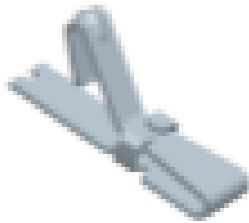


Plating

3u"MIN GOLD PLATING ON CONTACT AREA,GOLD FLASH PLATING ON SOLDER AREA,50u" MIN NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
1.6H Clips	3.5*1.0*1.9	stainless steel

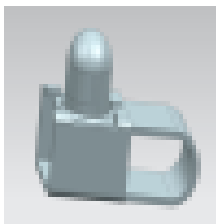


Plating

10u" Min GOLD PLATING ON CONTACT AREA,3u" Min GOLD PLATING ON SOLDER AREA,50u" MIN NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
0.70-0.95H Clips	3.2*1.0*1.35	TICU T0.08mm



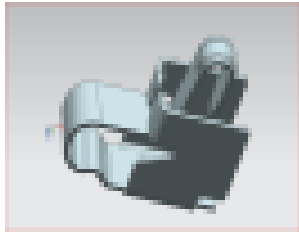
Plating

3u"MIN GOLD PLATING ON CONTACT AREA,GOLD FLASH PLATING ON SOLDER AREA,50u" MIN NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
2.3H Clips	4.38*1.9*3	Cu alloy T0.15mm

Pulse Part Number SW0185N



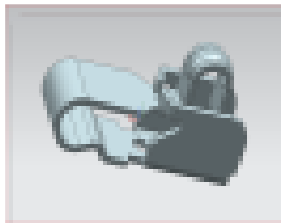
Plating

8u" Min GOLD PLATING ON CONTACT AREA,3u"
Min GOLD PLATING ON SOLDER AREA,50u" MIN
NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
3.0H Clips	3.5*1.50*3.5	C17200 T0.1mm

Pulse Part Number SW0186N



Plating

3u"MIN GOLD PLATING ON CONTACT AREA,GOLD
FLASH PLATING ON SOLDER AREA,50u" MIN
NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
1.5H Clips	3.4*0.90*1.8	SUS304-H T0.1mm

Pulse Part Number SW0187N



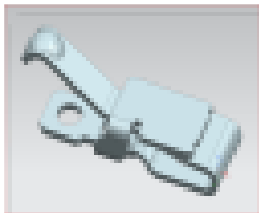
Plating

8u" Min GOLD PLATING ON CONTACT AREA,3u"
Min GOLD PLATING ON SOLDER AREA,50u" MIN
NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
1.0H Clips	3.2*1.0*1.4	C17200 T=0.1mm

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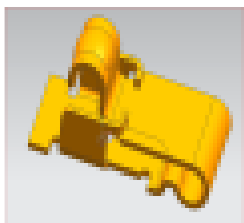


Plating

3u"MIN GOLD PLATING ON CONTACT AREA,GOLD FLASH PLATING ON SOLDER AREA,50u" MIN NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
0.75H Clips	3.26*1.0*1.24	SUS304-H T0.1mm

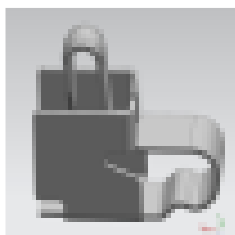


Plating

3u"MIN GOLD PLATING ON CONTACT AREA,GOLD FLASH PLATING ON SOLDER AREA,50u" MIN NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
1.2H Clips	2.95*1.5*1.6	SUS304-H T0.1mm



Plating

8u" Min GOLD PLATING ON CONTACT AREA,3u" Min GOLD PLATING ON SOLDER AREA,50u" MIN NICKEL PLATING OVER ALL;

Mechanical specifications

Working High	(L*W*H)mm	Material
2.7H Clips	5.0*1.1*3.5	Cu alloy T0.1mm

Pulse Part Number J37-08851

Mechanical specifications



Name	Au plating thickness	Package
Nade 1A Clip	Min 0.1 um	Bulk

Pulse Part Number J91-12571

Mechanical specifications



Name	Au plating thickness	Package
Clip-PSU-A	Min 0.1 um	Tape and Reel

Pulse Part Number CW9908

Mechanical specifications



Name	Au plating thickness	Package
H91-00285	Min 0.5 um	Tape and Reel

Pulse Part Number CW9909

Mechanical specifications



Name	Au plating thickness	Package
H91-00286	Min 0.1 um	Tape and Reel

Pulse Part Number CW9914

Mechanical specifications



Name	Au plating thickness	Package
H91-00293	Min 0.4 um	Tape and Reel

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